



Docket No.: 1155-0271P
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Masahiro SAWADA et al.

✓ Application No.: 10/607,519

Confirmation No.: 6031

Filed: June 27, 2003

Art Unit: 1711

For: POLYAMIDE RESIN COMPOSITION AND
MOLDED ARTICLE THEREOF

Examiner: A. L. Woodward

*OK to
enter
file
8/10/05*

SECOND AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated March 7, 2005, finally rejecting claims 1-6, the period for reply being extended two (2) monthS to August 7, 2005, please amend the above-identified U.S. patent application as follows. An Amendment, Petition for One Month Extension of Time and appropriate fee were filed on July 7, 2005.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.